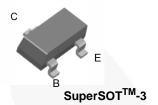


January 2014

# FSB749 PNP Low Saturation Transistor

## **Description**

These devices are designed with high-current gain and low saturation voltage with collector currents up to 3 A continuous. Sourced from process PC.



## **Ordering Information**

Part Number	Top Mark	Package	Packing Method
FSB749	749	SSOT 3L	Tape and Reel

## **Absolute Maximum Ratings**(1),(2)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^{\circ}C$  unless otherwise noted.

Symbol	Parameter	Value	Unit
V <sub>CEO</sub>	Collector-Emitter Voltage	-25	V
V <sub>CBO</sub>	Collector-Base Voltage	-35	V
V <sub>EBO</sub>	Emitter-Base Voltage	-5	V
I <sub>C</sub>	Collector Current - Continuous	-3	Α
T <sub>J</sub> , T <sub>STG</sub> Operating and Storage Junction Temperature Range		-55 to +150	°C

## Notes:

- 1. These ratings are based on a maximum junction temperature of 150°C.
- 2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty cycle operations.

## Thermal Characteristics(3)

Values are at  $T_A = 25^{\circ}C$  unless otherwise noted.

Symbol	Parameter	Max.	Unit
$P_{D}$	Total Device Dissipation	500	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	250	°C/W

## Note:

3. PCB size: FR-4 76 x 114 x 1.57  $\text{mm}^3$  (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

## **Electrical Characteristics**(4)

Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = -10 mA	-25		V
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	I <sub>C</sub> = -100 μA	-35		V
BV <sub>EBO</sub> Emitter-Base Breakdown Voltage		I <sub>E</sub> = -100 μA	-5.0		V
1	Collector Cut-Off Current	V <sub>CB</sub> = -30 V		-100	nA
I <sub>CBO</sub>		$V_{CB} = -30 \text{ V}, T_A = 100 ^{\circ}\text{C}$		-10	μΑ
I <sub>EBO</sub>	Emitter Cut-Off Current	V <sub>EB</sub> = -4 V		-100	nA
	DC Current Gain	$I_C = -50 \text{ mA}, V_{CE} = -2 \text{ V}$	70		
h		I <sub>C</sub> = -1.0 A, V <sub>CE</sub> = -2 V	100	300	
h <sub>FE</sub>		I <sub>C</sub> = -2.0 A, V <sub>CE</sub> = -2 V	75		
		I <sub>C</sub> = -6.0 A, V <sub>CE</sub> = -2 V	15		
\/ (cat)	Collector-Emitter Saturation Voltage	$I_C = -1 \text{ A}, I_B = -100 \text{ mA}$		-300	mV
V <sub>CE</sub> (sat)		$I_C = -3 \text{ A}, I_B = -300 \text{ mA}$		-600	IIIV
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	I <sub>C</sub> = -1 A, I <sub>B</sub> = -100 mA		-1.25	V
V <sub>BE</sub> (on) Base-Emitter On Voltage		I <sub>C</sub> = -1 A, V <sub>CE</sub> = -2 V		-1	V
C <sub>ob</sub> Output Capacitance		V <sub>CB</sub> = -10 V, I <sub>E</sub> = 0, f = 1 MHz		100	pF
f <sub>T</sub> Current Gain - Bandwidth Product		I <sub>C</sub> = -100 mA, V <sub>CE</sub> = -5 V, f = 100 MHz	100		MHz

#### Note

4. Pulse test: pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2.0%.

## **Physical Dimensions**

## SSOT 3L

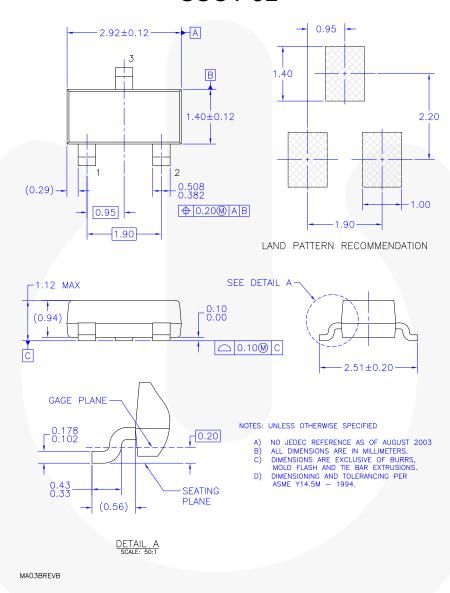


Figure 1. MOLDED PACKAGE, SUPERSOT, 3-LEAD (ACTIVE)

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Definition of Terms			
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